

Sound Processor with Built-in 2-band Equalizer BD37511FS

General Description

BD37511FS is a sound processor with built-in 2-band equalizer for car audio. The functions are 3ch stereo input selector, input-gain control, main volume and 4ch fader volume. Moreover, its "Advanced switch circuit", which is an original ROHM technology, can reduce various switching noise (ex. No-signal, low frequency like 20Hz & large signal inputs). "Advanced switch" makes control of microcomputer easier, supporting the construction of a high quality car audio system.

Features

- Reduce switching noise of mute, main volume, fader volume, bass, trebles by using advanced switch circuit
- Built-in 3 single-ended input selectors
- Decrease the number of external components due to built-in 2-band equalizer filter.
- It is possible to adjust the gain of the bass and treble up to ±20dB with 1 dB step gain adjustment.
- Energy-saving design resulting in low current consumption, by utilizing the Bi-CMOS process. It has the advantage in quality over scaling down the power heat control of the internal regulators.
- Input terminals and output terminals are organized and separately laid out to keep the signal flow in one direction which results in simpler and smaller PCB layout.
- It is possible to control the I²C BUS by 3.3V / 5V.

Applications

It is optimal for use in car audio systems. It can also be used for audio equipment of mini Compo, micro Compo, TV. etc.

Key Specifications

Power Supply Voltage Range: 7.0V to 9.5V Circuit Current (No Signal): 15mA(Typ) Total Harmonic Distortion: 0.005%(Typ) Maximum Input Voltage: 2.3Vrms (Typ) -100dB(Typ) Cross-talk Between Selectors: Volume Control Range: +0dB to -40dB Output Noise Voltage: 6µVrms(Typ) 2µVrms(Typ) Residual Output Noise Voltage: Operating Temperature Range: -40°C to +85°C

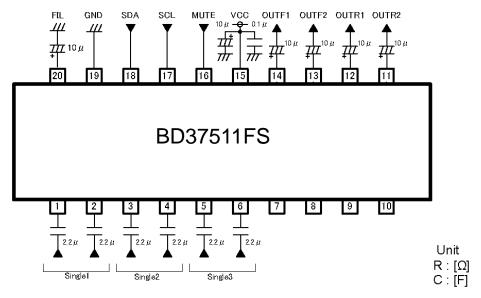
Package

W(Typ) x D(Typ) x H(Max)

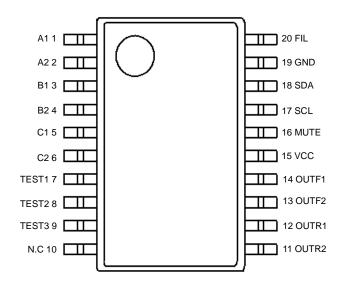


SSOP-A20 8.70mm x 7.80mm x 2.01mm

Typical Application Circuit



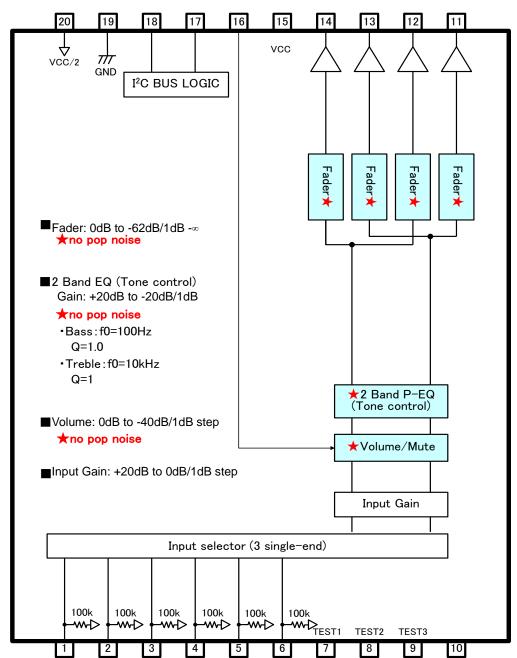
Pin Configuration



Pin Descriptions

in Descript	ions				
Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	A1	A input terminal of 1ch	11	OUTR2	Rear output terminal of 2ch
2	A2	A input terminal of 2ch	12	OUTR1	Rear output terminal of 1ch
3	B1	B input terminal of 1ch	13	OUTF2	Front output terminal of 2ch
4	B2	B input terminal of 2ch	14	OUTF1	Front output terminal of 1ch
5	C1	C input terminal of 1ch	15	VCC	Power supply terminal
6	C2	C input terminal of 2ch	16	MUTE	External compulsory mute terminal
7	TEST1	Test Pin	17	SCL	I ² C Communication clock terminal
8	TEST2	Test Pin	18	SDA	I ² C Communication data terminal
9	TEST3	Test Pin	19	GND	GND terminal
10	N.C.	No Connection	20	FIL	VCC/2 terminal

Block Diagram



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage	Vcc	10.0	V
Input Voltage	V _{IN}	V _{CC} +0.3 to GND-0.3	V
Power Dissipation	Pd	0.94 ^(Note 1)	W
Storage Temperature	Tstg	-55 to +150	°C

(Note 1) This value derates by 7.5mW/°C for Ta=25°C or more when ROHM standard board is used. Thermal resistance θja = 133.3(°C/W) ROHM Standard board

Size: 70 x 70 x 1.6(mm³)

Material : A FR4 grass epoxy board(3% or less of copper foil area)

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Unit
Power Supply Voltage	Vcc	7.0	-	9.5	V
Temperature	Topr	-40	-	+85	°C

Electrical Characteristics

(Unless specified otherwise, Ta=25°C, V_{CC}=8.5V, f=1kHz, V_{IN} =1Vrms, Rg=600Ω, R_L=10kΩ, A input, Input gain 0dB, Mute OFF, Volume 0dB, Tone control 0dB, Loudness 0dB, Fader 0dB)

X	CTT, Volume Cab, Tone Control Cab,		,	Limit			
BLOCK	Parameter	Symbol	Min	Тур	Max	Unit	Conditions
	Circuit Current	IQ	-	15	30	mA	No signal
	Voltage Gain	Gv	-1.5	0	+1.5	dB	G _V =20log(V _{OUT} /V _{IN})
	Channel Balance	СВ	-1.5	0	+1.5	dB	CB = G _{V1} -G _{V2}
	Total Harmonic Distortion	THD+N1	1	0.005	0.05	%	V _{OUT} =1Vrms BW=400Hz-30KHz
3AL	Output Noise Voltage *	V _{NO1}	-	6	25	μVrms	$Rg = 0\Omega$ BW = IHF-A
GENERAL	Residual Output Noise Voltage *	V _{NOR}	-	2	10	μVrms	Fader = -∞dB Rg = 0Ω BW = IHF-A
	Cross-talk Between Channels *	СТС	-	-100	-90	dB	$Rg = 0\Omega$ $CTC=20log(V_{OUT}/V_{IN})$ $BW = IHF-A$
	Ripple Rejection	RR	-	-70	-40	dB	f=1KHz V _{RR} =100mVrms RR=20log(V _{CC} IN/V _{OUT})
8	Input Impedance(A, B, C)	R _{IN} _s	70	100	130	kΩ	
SELECTOR	Maximum Input Voltage	V _{IM}	2.1	2.3	ı	Vrms	V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz
INPUT SEI	Cross-talk Between Selectors *	стѕ	-	-100	-90	dB	$Rg = 0\Omega$ $CTS=20log(V_{OUT}/V_{IN})$ $BW = IHF-A$
Z	Minimum Input Gain	G _{IN_MIN}	-2	0	+2	dB	Input gain 0dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
INPUT GAIN	Maximum Input Gain	GIN_MAX	18	20	22	dB	Input gain 20dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
	Gain Set Error	G _{IN_ERR}	-2	0	+2	dB	GAIN=+1dB to +20dB

Electrical Characteristics - continued

	al Characteristics - continue	4		Limit			
BLOCK	Parameter	Symbol	Min	Тур	Max	Unit	Conditions
MUTE	Mute Attenuation *	G _{м∪те}	ı	-105	-85	dB	Mute ON G _{MUTE} =20log(V _{OUT} /V _{IN}) BW = IHF-A
IME	Maximum Attenuation	G _{V_MIN}	-43	-40	-37	dB	Volume = $-40dB$ G _V = $20log(V_{OUT}/V_{IN})$
VOLUME	Attenuation Set Error 1	G _{V_ERR1}	-2	0	+2	dB	GAIN & ATT=0dB to -15dB
>	Attenuation Set Error 2	G _{V_ERR2}	-3	0	+3	dB	ATT=-16dB to -40dB
	Maximum Boost Gain	G _{B_BST}	18	20	22	dB	Gain=+20dB f=100Hz V _{IN} =100mVrms G _B =20log (V _{OUT} /V _{IN})
BASS	Maximum Cut Gain	G _{B_CUT}	-22	-20	-18	dB	Gain=-20dB f=100Hz V _{IN} =2Vrms G _B =20log (V _{OUT} /V _{IN})
	Gain Set Error	G _{B_ERR}	-2	0	+2	dB	Gain=-20dB to +20dB f=100Hz
ш	Maximum Boost Gain	GT_BST	18	20	22	dB	Gain=+20dB f=10kHz V _{IN} =100mVrms G _T =20log (V _{OUT} /V _{IN})
TREBLE	Maximum Cut Gain	Gт_сит	-22	-20	-18	dB	Gain=-20dB f=10kHz V _{IN} =2Vrms G _T =20log (V _{OUT} /V _{IN})
	Gain Set Error	Gt_err	-2	0	+2	dB	Gain=-20dB to +20dB f=10kHz
	Maximum Attenuation *	Gf_min	-	-100	-90	dB	Fader = -∞dB G _F =20log(V _{OUT} /V _{IN}) BW = IHF-A
	Attenuation Set Error 1	GF_ERR1	-2	0	+2	dB	ATT=0dB to -15dB
FADER	Attenuation Set Error 2	GF_ERR2	-3	0	+3	dB	ATT=-16dB to -47dB
FAI	Attenuation Set Error 3	G _{F_ERR3}	-4	0	+4	dB	ATT=-48dB to -62dB
	Output Impedance	R _{OUT}	-	-	50	Ω	V _{IN} =100mVrms
	Maximum Output Voltage	Vом	2	2.2	-	Vrms	THD+N=1% BW=400Hz-30KHz

 $[\]label{lem:possible} \mbox{VP-9690A (Average value detection, effective value display) filter by Matsushita Communication is used for * measurement. Phase between input / output is same.}$

Typical Performance Curves

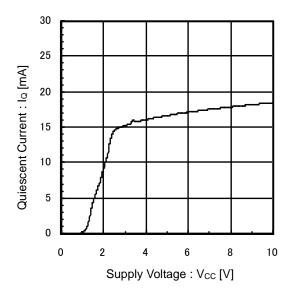


Figure 1. Quiescent Current vs Supply Voltage

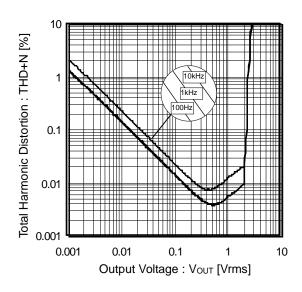


Figure 2. Total Harmonic Distortion vs Output Voltage

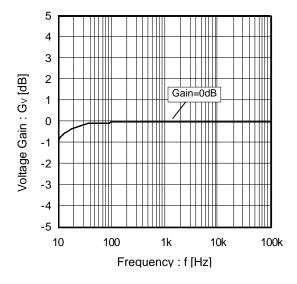


Figure 3. Voltage Gain vs Frequency

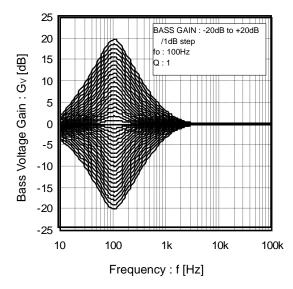


Figure 4. Bass Voltage Gain vs Frequency

Typical Performance Curves - continued

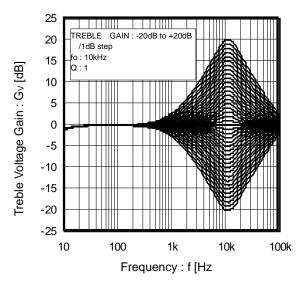


Figure 5. Treble Voltage Gain vs Frequency

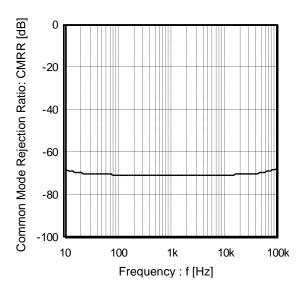


Figure 6. Common Mode Rejection Ratio vs Frequency

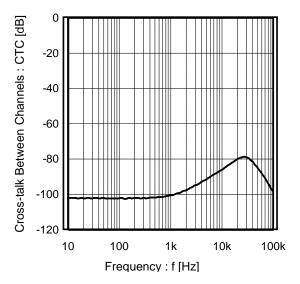


Figure 7. Cross-Talk Between Channels vs Frequency

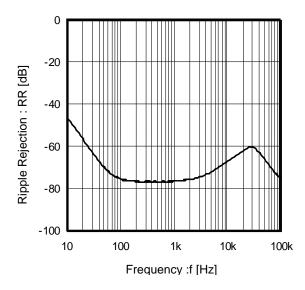


Figure 8. Ripple Rejection Ratio vs Frequency

Typical Performance Curves - continued

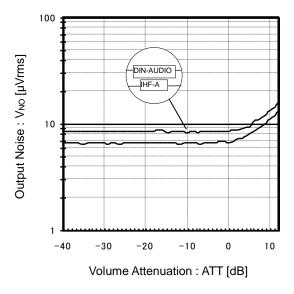


Figure 9. Output Noise vs Volume Attenuation

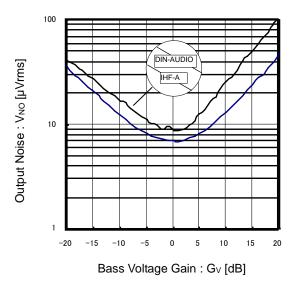
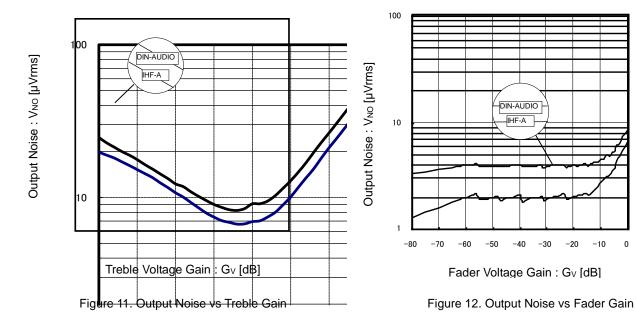


Figure 10. Output Noise vs Bass Voltage Gain



Typical Performance Curves - continued

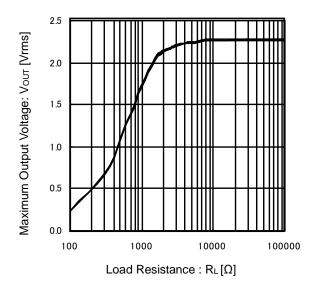


Figure 13. Maximum Output Voltage vs Load Resistance

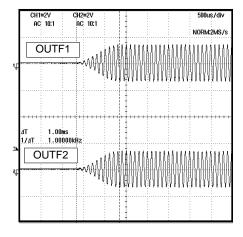


Figure 14. Advanced Switch 1

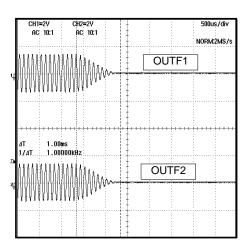


Figure 15. Advanced Switch 2

Timing Chart

Control Signal Specification

(1) Electrical Specifications and Timing for Bus Lines and I/O Stages

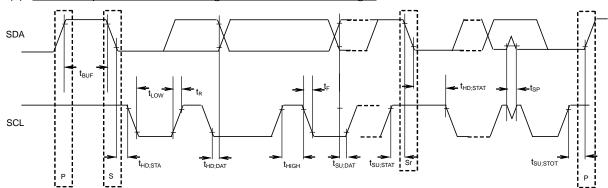


Figure 16. I2C-bus Signal Timing Diagram

Table 1 Characteristics of the SDA and SCL bus lines for I²C-bus devices

	Parameter	Symbol	Fast-mod	le l ² C-bus	Unit
	Falametei	Symbol	Min	Max	Offic
1	SCL clock frequency	fscL	0	400	kHz
2	Bus free time between a STOP and START condition	t _{BUF}	1.3	-	μS
3	Hold time (repeated) START condition. After this period, the first clock	t	0.6		0
3	pulse is generated	thd;sta	0.6	-	μS
4	LOW period of the SCL clock	tLOW	1.3	-	μS
5	HIGH period of the SCL clock	t _{HIGH}	0.6	-	μS
6	Set-up time for a repeated START condition	tsu;sta	0.6	-	μS
7	Data hold time:	thd;dat	0.7 (Note)	-	μS
8	Data set-up time	tsu;dat	700	-	ns
9	Set-up time for STOP condition	tsu;sto	0.6	-	μS

All values referred to VIH Min and VIL Max Levels (see Table 2).

(Note) To avoid sending right after the fall-edge of SCL (VIHmin of the SCL signal), the transmitting device should set a hold time of 300ns or more for the SDA signal.

For $7(t_{\text{HD;DAT}})$, $8(t_{\text{SU;DAT}})$, make the setup in which the margin is fully in.

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

	Parameter	Cumbal	Fast-mode	e devices	Unit
	Farameter	Symbol	Min	Max	Offic
10	LOW level input voltage:	V_{IL}	-0.3	+1	V
11	HIGH level input voltage:	V _{IH}	2.3	5	V
12	Pulse width of spikes which must be suppressed by the input filter.	t _{SP}	0	50	ns
13	LOW level output voltage: at 3mA sink current	V _{OL1}	0	0.4	V
14	Input current of each I/O pin with an input voltage between 0.4V and 4.5V.	I _I	-10	+10	μA

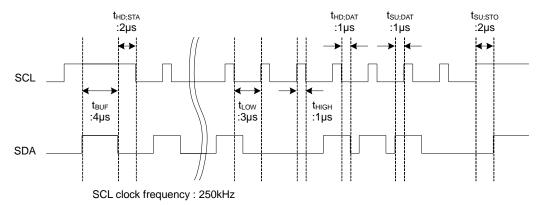


Figure 17. I²C Data Transmission Command Timing Diagram

(2) <u>I²C BUS FORMAT</u>

	MSB LSB		MSB	LSB		MSB I	_SB			
S	Slave Address	Α	Select Ad	ldress	Α	Data		Α	Р	
1bit	8bit	1bit	8b	oit ´	1bit	8bit		1bit	1bit	
	S		art condition (I							
	Slave Address	,							e address.	
		The least significant bit is "L" which corresponds to write mode.								
	Α	= AC	KNOWLEDG	E bit (Reco	gniti	on of acknowledge	ment)			
	Select Address	= Se	lect address	correspond	ing t	o volume, bass or t	reble.			
	Data	= Da	ita on every v	olume and	tone					
	Р	= Sto	op condition (I	Recognition	n of s	stop bit)				

(3) I²C BUS Interface Protocol

(a) Basic Format

S | Slave Address | A | Select Address | A | Data | A | P |

MSB | LSB | MSB | LSB | MSB | LSB |

(b) Automatic Increment (Select Address increases (+1) according to the number of data.)

 (,				\	/	9			,			
S	Slave Address	Α	Select Address	Α	Data1	Α	Data2	Α		DataN	Α	Р
	MSB LSE	3	MSB LSE	3 N	ISB LSB	N	ISB LSB	,	MS	SB LSE	3	

(Example) ①Data1 shall be set as data of address specified by Select Address.

- ②Data2 shall be set as data of address specified by Select Address +1.
- ③DataN shall be set as data of address specified by Select Address +N-1.

(c) Configuration Unavailable for Transmission (In this case, only Select Address1 is set.)

ſ	S	Slave Address	Α	Select Address	1 A	Data	Α	Select Ad	dress 2	Α	Data	Α	Р
		MSB LSB	Ν	MSB L	SB I	MSB LSB		MSB	LSB	Μ	ISB L	SB	
		(Note) If any	data	a is transmitted as	s Sele	ct Address	s 2 n	ext to data,	it is reco	gniz	zed		
		as	data	not as Select Ac	ddress	: 2							

(4) Slave Address

MSB							LSB	
A6	A5	A4	A3	A2	A1	A0	R/W	
1	0	0	0	0	0	0	0	80H

(5) Select Address & Data

	Select	MSB			Da	ıta			LSB		
Items	Address (hex)	D7	D6	D5	D4	D3	D2	D1	D0		
Initial setup 1	01	Advance d switch ON/OFF	0	time	d switch e of one/Fader	0	0		ed switch of Mute		
Input Selector	04	0	0	0	0	0	lı lı	nput select	or		
Input gain	06	Mute ON/OFF	0	0		ı	nput Gain				
Volume gain	20	1	0			Volume Att	enuation				
Fader 1ch Front	28	1	0			Fader Atte	* * * * * * * * * * * * * * * * * * * *				
Fader 2ch Front	29	1	0			Fader Atte	nuation				
Fader 1ch Rear	2A	1	0			Fader Atte	nuation				
Fader 2ch Rear	2B	1	0			Fader Atte	nuation				
Bass gain	51	Bass Boost/ Cut	0	0			Bass Gain				
Treble gain	57	Treble Boost/ Cut	0	0		Treble Gain					
System Reset	FE	1	0	0	0	0	0	0	1		

Advanced switch

Note

- 1. The Advanced Switch works in the latch part while changing from one function to another.
- 2. When changing a tone into the cut from the boost, or the cut and the boost, always go via the condition of the tone 0dB.
- 3. Upon continuous data transfer, the Select Address rolls over because of the automatic increment function, as shown below.

$$\longrightarrow 01 \longrightarrow 04 \longrightarrow 06 \longrightarrow 20 \longrightarrow 28 \longrightarrow 29 \longrightarrow 2A \longrightarrow 2B \longrightarrow 51 \longrightarrow 57$$

- 4. For the function of Input Selector etc, Advanced Switch is not used. Therefore, please apply mute on the set side when changing these settings.
- 5. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF while waiting for advanced-mute time.

Select address 01 (hex)

Ocicol addices of (fick)									
Mode	MSB		Advanced switch time of Mute						
iviode	D7	D6	D5	D4	D3	D2	D1	D0	
0.6msec	A al. (a. a. a. a. al						0	0	
1.2msec	Advanced		Advanced	switch time	0	0	0	1	
2.4msec	Switch ON/OFF	0	of Volume/	Tone/Fader	U	U	1	0	
4.8msec	ON/OFF						1	1	

Mode	MSB		,		witch time o one/Fader	ıf		LSB
	D7	D6	D5	D4	D3	D2	D1	D0
4.6 msec	A di (0 0 0 0 d		0	0				
9.3 msec	Advanced Switch	0	0	1	0	0	Advance	ed switch
18.6 msec	ON/OFF	U	1	0	U	U	Time o	of Mute
37.2 msec	OIN/OFF		1	1				

Mode	MSB		Advanced switch ON/OFF					
Mode	D7	D6	D5 D4 D3 D2 D1					D0
OFF	0	0	Advanced switch time		0	0	Advanced switch	
ON	1	U	of Volume/Tone/Fader		0	0	Time o	of Mute

Select address 04(hex)

Mada	MSB			Input Sel	ector			LSB
Mode	D7	D6	D5	D4	D3	D2	D1	D0
A						0	0	0
В						0	0	1
С			0	_	0	0	1	0
SHORT			U	0	U	1	0	1
INPUT MUTE	1					1	1	0
INFOLIMOTE						1	1	1

:Initial condition

SHORT : The input impedance of each input terminal is lowered from 100k Ω (TYP) to 6 k Ω (TYP). (For quick charge of coupling capacitor)

INPUT MUTE: Mute is done at the input signal in the part of Input Selector.

Select address 06 (hex)

Cain	MSB			Inpu	t Gain			LSB
Gain	D7	D6	D5	D4	D3	D2	D1	D0
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB				0	1	0	0	1
10dB				0	1	0	1	0
11dB	Mute	_	_	0	1	0	1	1
12dB	ON/OFF	0	0	0	1	1	0	0
13dB				0	1	1	0	1
14dB				0	1	1	1	0
15dB				0	1	1	1	1
16dB				1	0	0	0	0
17dB				1	0	0	0	1
18dB				1	0	0	1	0
19dB				1	0	0	1	1
20dB				1	0	1	0	0
				1	1	0	1	1
Prohibition				:	:	:	:	:
				1	1	1	1	1

(Note) In case sending prohibited data, 0dB is set.

Mode	MSB			Mute	ON/OFF			LSB
Mode	D7	D6	D5	D4	D3	D2	D1	D0
OFF	0	0	0			Innut Coin		
ON	1] "	U			Input Gain		

:Initial condition

Select address 20 (hex)

Gain & ATT	MSB			Vol Atte	nuation			LSB
Gain & Air	D7	D6	D5	D4	D3	D2	D1	D0
0dB			0	0	0	0	0	0
-1dB			0	0	0	0	0	1
-2dB			0	0	0	0	1	0
•			•	•	•	•	•	•
•			•	•	•	•	•	•
•			•	•	•	•	•	•
-38dB	1	0	1	0	0	1	1	0
-39dB	'	Ü	1	0	0	1	1	1
-40dB			1	0	1	0	0	0
			1	0	1	0	0	1
Prohibition			:	:	:	:	:	:
TOTAL			1	1	1	1	1	0
			1	1	1	1	1	1

(Note) In case sending prohibited data, -40dB is set.

Select address 28, 29, 2A, 2B (hex)

Gain & ATT	MSB		Fader Attenuation					
Gaill & Al I	D7	D6	D5	D4	D3	D2	D1	D0
0dB			0	0	0	0	0	0
-1dB			0	0	0	0	0	1
-2dB			0	0	0	0	1	0
•			•	•	•	•	•	•
•	1	0	•	•	•	•	•	•
•			•	•	•	•	•	•
-61dB			1	1	1	1	0	1
-62dB			1	1	1	1	1	0
-∞dB			1	1	1	1	1	1

: Initial condition

Select address 51, 57 (hex)

Gain	MSB			Bass/Tre	eble Gain			LSB
Gain	D7	D6	D5	D4	D3	D2	D1	D0
0dB				0	0	0	0	0
1dB				0	0	0	0	1
2dB				0	0	0	1	0
3dB				0	0	0	1	1
4dB				0	0	1	0	0
5dB				0	0	1	0	1
6dB				0	0	1	1	0
7dB				0	0	1	1	1
8dB				0	1	0	0	0
9dB				0	1	0	0	1
10dB	_ ,			0	1	0	1	0
11dB	Bass/			0	1	0	1	1
12dB	Treble	0	0	0	1	1	0	0
13dB	Boost			0	1	1	0	1
14dB	/cut			0	1	1	1	0
15dB				0	1	1	1	1
16dB				1	0	0	0	0
17dB				1	0	0	0	1
18dB				1	0	0	1	0
19dB				1	0	0	1	1
20dB				1	0	1	0	0
				1	0	1	0	1
Prohibition				:	:	•	•	:
		1	1	1	1	0		
				1	1	1	1	1

(Note) In case sending prohibited data, 0dB is set.

Mode	MSB			Bass/Treble	Boost/Cut			LSB
Iviode	D7	D6	D5	D4	D3	D2	D1	D0
Boost	0	0	0		De	ss/Treble Ga	nin.	
Cut	1] "	0		Do	iss/freble Ga	alli	

:Initial condition

(6) About Power ON Reset

Built-in IC initialization is made during power on of the supply voltage. Please send initial data to all addresses at supply voltage on. And please turn ON mute at the set side until this initial data is sent.

at Supply Voltage on. And p	iease tuili	ON IIIule	at the se	t Side un	ui uii5 iiii	liai uala is seiil.	
_			Limit				
Parameter	Symbol	Min	Тур	Max	Unit	Conditions	
Rise Time of VCC	t _{RISE}	20	-	-	µsec	V _{CC} rise time from 0V to 3V	
VCC Voltage of Release Power ON Reset	V _{POR}	-	4.1	-	V		

(7) About External Compulsory Mute Terminal

It is possible to force mute externally by setting an input voltage to the MUTE terminal.

Mute Voltage Condition	Mode
GND to 1.0V	MUTE ON
2.3V to Vcc	MUTE OFF

Establish the voltage of MUTE in the condition to be defined.

Application Information

1. Function and Specifications

Function	Specifications						
Input selector	· Stereo 3 input						
Input gain	· 0dB to 20dB						
Mute	Possible to use "Advanced switch" for prevention of switching noise.						
Volume	· 0dB to -40dB (1dB step)						
volume	Possible to use "Advanced switch" for prevention of switching noise.						
Bass	· -20dB to +20dB (1dB step)						
	· Q=1						
Dass	· fo=100Hz						
	Possible to use advanced switch at changing gain						
	· -20dB to +20dB (1dB step)						
Treble	· Q=1						
	· fo=10kHz						
	Possible to use advanced switch at changing gain						
Fader	· 0dB to -62dB(1dB step), -∞dB						
i adei	Possible to use "Advanced switch" for prevention of switching noise.						

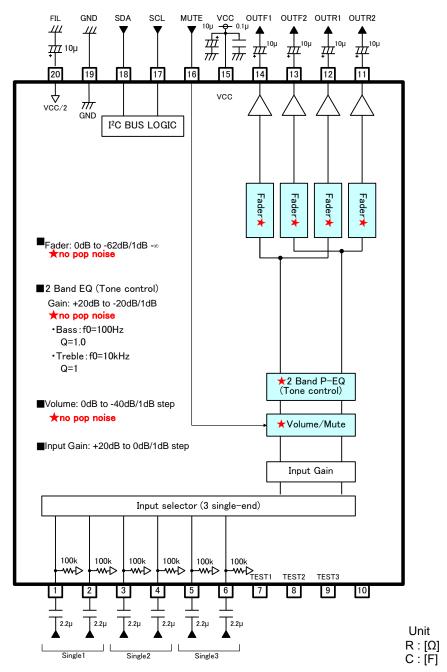
2. Volume / Fader Volume Attenuation Data

(dB)	D7	D6	D5	D4	D3	D2	D1	D0	(dB)	D7	D6	D5	D4	D3	D2	D1	D0
0			0	0	0	0	0	0	-32			1	0	0	0	0	0
-1			0	0	0	0	0	1	-33			1	0	0	0	0	1
-2			0	0	0	0	1	0	-34			1	0	0	0	1	0
-3			0	0	0	0	1	1	-35			1	0	0	0	1	1
-4			0	0	0	1	0	0	-36			1	0	0	1	0	0
-5			0	0	0	1	0	1	-37			1	0	0	1	0	1
-6			0	0	0	1	1	0	-38			1	0	0	1	1	0
-7			0	0	0	1	1	1	-39			1	0	0	1	1	1
-8			0	0	1	0	0	0	-40			1	0	1	0	0	0
-9			0	0	1	0	0	1	-41			1	0	1	0	0	1
-10			0	0	1	0	1	0	-42			1	0	1	0	1	0
-11			0	0	1	0	1	1	-43			1	0	1	0	1	1
-12			0	0	1	1	0	0	-44			1	0	1	1	0	0
-13			0	0	1	1	0	1	-45			1	0	1	1	0	1
-14			0	0	1	1	1	0	-46			1	0	1	1	1	0
-15	1	0	0	0	1	1	1	1	-47	1	0	1	0	1	1	1	1
-16	'	U	0	1	0	0	0	0	-48	'	U	1	1	0	0	0	0
-17			0	1	0	0	0	1	-49			1	1	0	0	0	1
-18			0	1	0	0	1	0	-50			1	1	0	0	1	0
-19			0	1	0	0	1	1	-51			1	1	0	0	1	1
-20			0	1	0	1	0	0	-52			1	1	0	1	0	0
-21			0	1	0	1	0	1	-53			1	1	0	1	0	1
-22			0	1	0	1	1	0	-54			1	1	0	1	1	0
-23			0	1	0	1	1	1	-55			1	1	0	1	1	1
-24			0	1	1	0	0	0	-56			1	1	1	0	0	0
-25			0	1	1	0	0	1	-57			1	1	1	0	0	1
-26			0	1	1	0	1	0	-58			1	1	1	0	1	0
-27			0	1	1	0	1	1	-59			1	1	1	0	1	1
-28			0	1	1	1	0	0	-60			1	1	1	1	0	0
-29			0	1	1	1	0	1	-61			1	1	1	1	0	1
-30			0	1	1	1	1	0	-62			1	1	1	1	1	0
-31			0	1	1	1	1	1	-∞			1	1	1	1	1	1

For Volume attenuation, only 0dB to -40dB are available.

	:	Initial	condition
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3. Application Circuit



Notes on wiring

- ① Please connect the decoupling capacitor of the power supply in the shortest possible distance to GND.
- ② GND lines should be one-point connected.
- ③ Wiring pattern of Digital should be away from that of Analog unit and cross-talk should not be acceptable.
- 4 SCL and SDA lines of I²C BUS should not be parallel if possible. The lines should be shielded, if they are adjacent to each other.
- ⑤ Analog input lines should not be parallel if possible. The lines should be shielded, if they are adjacent to each other.
- 6 For TEST pins (Pin 7,8,9), please leave them as OPEN.

Power Dissipation

About the thermal design of the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy the device. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.

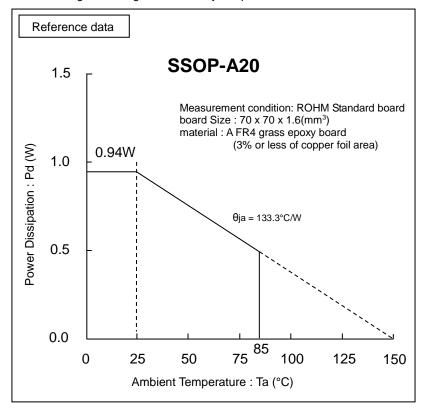


Figure 18. Temperature Derating Curve

(Note) Values are actual measurements and are not guaranteed.

Power dissipation values vary according to the board on which the IC is mounted.

I/O Equivalent Circuits

	nt Circuits			
Terminal	Terminal	Terminal	Equivalent Circuit	Terminal Description
No.	Name	Voltage		A terminal for signal input.
1 2 3 4 5 6	A1 A2 B1 B2 C1 C2	4.25	VCC VIONK JAMON GND	The input impedance is 100kΩ(typ).
16	MUTE	_	VCC D D D D D D D D D D D D D D D D D D	A terminal for external compulsory mute. If terminal voltage is High level, the mute is off. And if the terminal voltage is Low level, the mute is on.
11 12 13 14	OUTR2 OUTR1 OUTF2 OUTF1	4.25	VCC GND GND	A terminal for fader and Subwoofer output.
15	VCC	8.5		Power supply terminal.
17	SCL	-	VCC O 1.65V	A terminal for clock input of I ² C BUS communication.

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

I/O Equivalent Circuits - continued

Terminal No.	Terminal Name	Terminal Voltage	Equivalent Circuit	Terminal Description
18	SDA	-	VCC O SND I.65V	A terminal for data input of I ² C BUS communication.
19	GND	0		Ground terminal.
20	FIL	4.25	VCC	Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in.
7	TEST1			TEST terminal.
8	TEST2	-		
9	TEST3			

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

Operational Notes - continued

12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode. When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

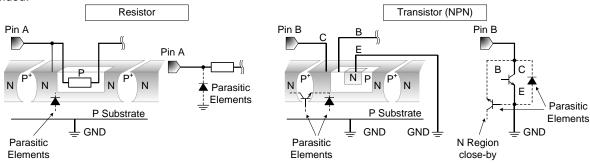
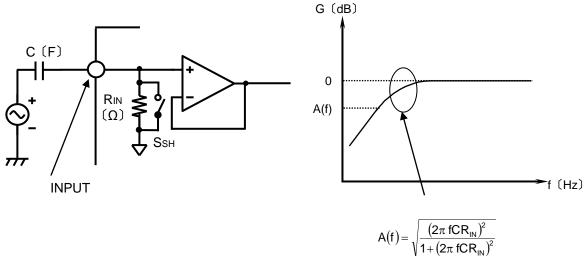


Figure 19. Example of monolithic IC structure

13. About a Signal Input Part

(a) About Input Coupling Capacitor Constant Value

In the input signal terminal, please decide the constant value of the input coupling capacitor C(F) that would be sufficient to form an RC characterized HPF with input impedance $R_{IN}(\Omega)$ inside the IC.



(b) About the Input Selector SHORT

SHORT mode is the command which makes switch S_{SH} =ON of input selector part so that the input impedance R_{IN} of all terminals becomes small. Switch S_{SH} is OFF when SHORT command is not selected.

The constant time brought about by the small resistance inside and the capacitor outside the LSI becomes small when this command is used. The charge time of the capacitor becomes short. Since SHORT mode turns ON the switch of S_{SH} and makes it low impedance, please use it at no signal condition.

14. About Mute Terminal(Pin 16) when power supply is OFF

There should be no applied voltage across the Mute terminal (Pin 16) when power-supply is OFF. A resistor (about $2.2k\Omega$) should be connected in series to Mute terminal in case a voltage is supplied to Mute terminal. (Please refer Application Circuit Diagram.)

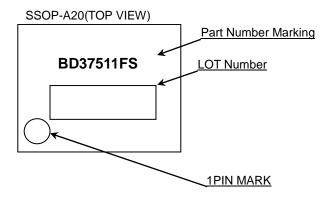
15. About TEST Pin

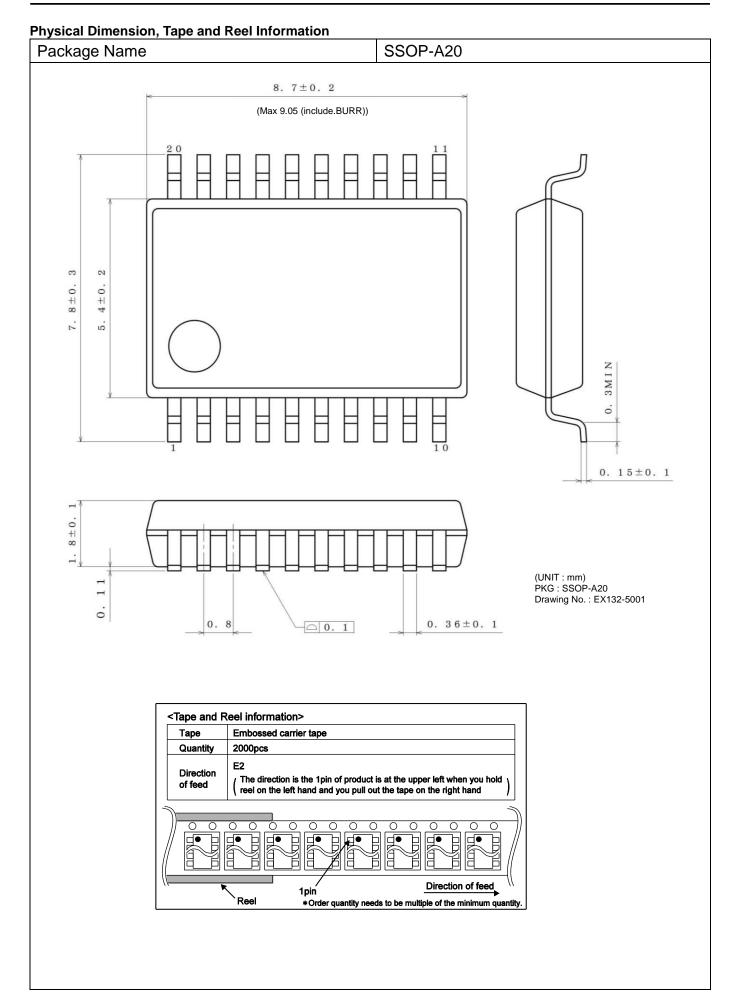
TEST Pin, should be OPEN. Pin 9, 8, 7 are TEST Pins.

Ordering Information



Marking Diagram





Revision History

Date	Revision	Changes
16.Dec.2015	001	New Release

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 - [h] Use of the Products in places subject to dew condensation
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